SSC8339GS1

Dual P-Channel Enhancement Mode MOSFET

### ➢ Features

VDS	VGS	RDSON Typ.	ID
-30V	±20V	15mR@-10V	-10A
		20mR@-4V5	

➢ Pin configuration

Top view

Bottom View
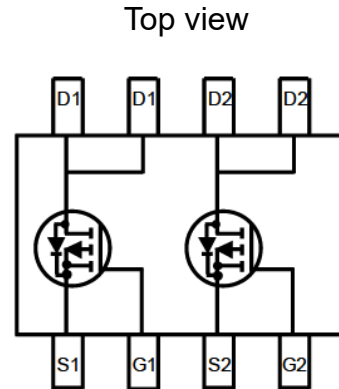
➢ Description

This device is produced with high cell density, DMOS trench technology, which is especially used to minimize on-state resistance. This device is particularly suited for low voltage power management requiring a wild range of given voltage ratings(4.5V~25V) such as load switch and battery protection.
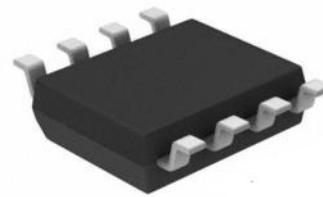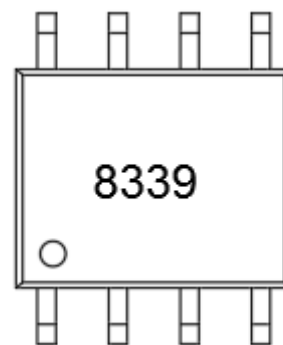
➢ Applications

● Load Switch

● DCDC conversion

● NB Battery

Marking

➢ Ordering Information

Device	Package	Shipping
SSC8339GS1	SOP-8	4000/Reel

➢ **Absolute Maximum Ratings**(T$_A$=25℃ unless otherwise noted)

Symbol	Parameter	Ratings	Unit
V$_{DSS}$	Drain-to-Source Voltage	-30	V
V$_{GSS}$	Gate-to-Source Voltage	±20	V
I$_D$	Continuous Drain Current [a]	-10	A
I$_{DM}$	Pulsed Drain Current [b]	-50	A
P$_D$	Power Dissipation [c]	5	W
P$_{DSM}$	Power Dissipation [a]	2	W
T$_J$	Operation junction temperature	-55 to 150	℃
T$_{STG}$	Storage temperature range	-55 to 150	℃

➢ **Thermal Resistance Ratings**(T$_A$=25℃ unless otherwise noted)

Symbol	Parameter	Typical	Maximum	Unit
R$_{\theta JA}$	Junction-to-Ambient Thermal Resistance [a]		70	℃/W
R$_{\theta JC}$	Junction-to-Case Thermal Resistance		30	

Note:

a. The value of RθJA is measured with the device mounted on 1 in^2 FR-4 board with 2oz.copper,in a still air environment with TA=25℃.The value in any given application depends on the user is specific board design. The current rating is based on the t≤ 10s thermal resistance rating.

b. Repetitive rating, pulse width limited by junction temperature.

c. The power dissipation PD is based on TJ(MAX)=150°C, using junction-to-case thermal resistance, and is more useful in setting the upper dissipation limit for cases where additional heat sinking is used.
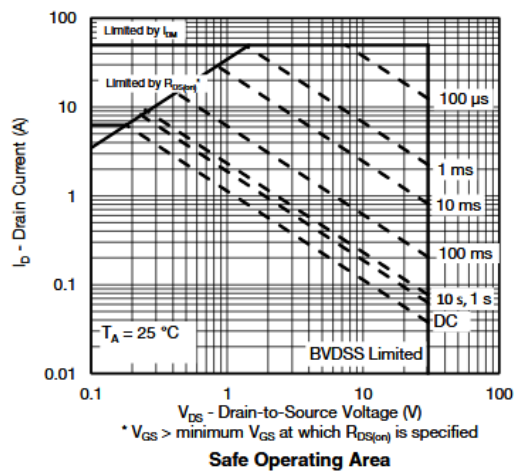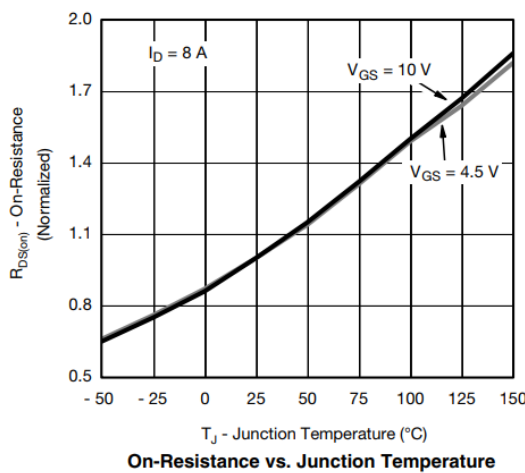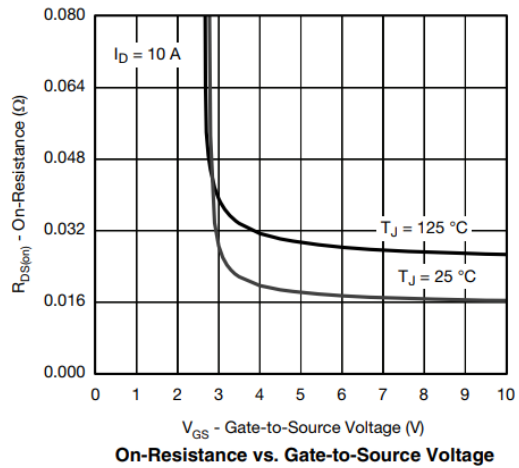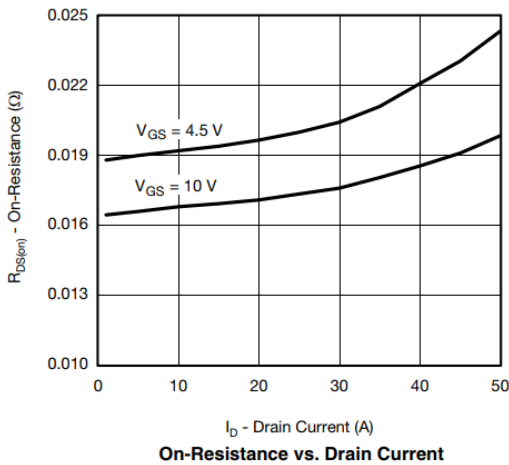
➢ **Electronics Characteristics**(T$_A$=25℃ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ.	Max	Unit
V$_{(BR)DSS}$	Drain-Source Breakdown Voltage	VGS=0V,ID=-250uA	-30			V
V$_{GS\ (th)}$	Gate Threshold Voltage	VDS=VGS,ID=-250uA	-1	-1.3	-3	V
R$_{DS(on)}$	Drain-Source On-Resistance	VGS=-10V,ID=-10A		15	20	mR
		VGS=-4.5V,ID=-7A		20	30	
I$_{DSS}$	Zero Gate Voltage Drain Current	VDS=-30V,VGS=0V			-1	uA
I$_{GSS}$	Gate-Source leak current	VGS=±20V,VDS=0V			±100	nA
V$_{SD}$	Forward Voltage	VGS=0V,IS=-1A		-0.8	-1.2	V
G$_{FS}$	Transconductance	VDS=-5V , ID=3.6A		13		S
Ciss	Input Capacitance	VDS=-20V, VGS=0V, f=1MHz		2000		pF
Coss	Output Capacitance			550		
Crss	Reverse Transfer Capacitance			800		
T$_{D(ON)}$	Turn-on delay time	VGS=-10V, VDS=-15V, RG=3R,RL=1.5R		9		ns
Tr	Rise time			8		
T$_{D(OFF)}$	Turn-off delay time			39		
Tf	Fall time			15		
Qg	Total Gate charge	VGS=-4.5V , VDS=-15V , ID=-3A		3		nC
Qgs	Gate to Source charge			0.6		
Qgd	Gate to Drain charge			1.1		

➢ **Typical Characteristics**(T_A=25℃ unless otherwise noted)

Output Characteristics

Transfer Characteristics

On-Resistance vs. Drain Current

On-Resistance vs. Gate-to-Source Voltage

On-Resistance vs. Junction Temperature

Safe Operating Area

Normalized Thermal Transient Impedance, Junction-to-Ambient
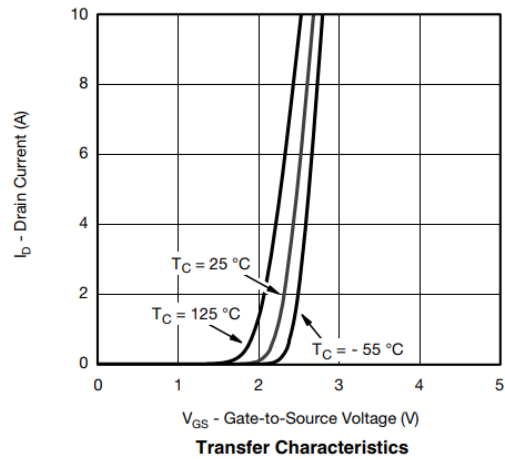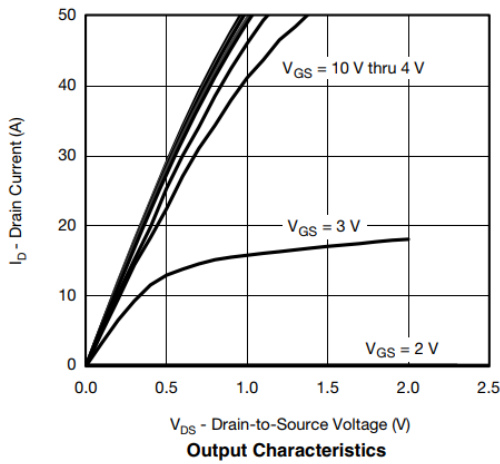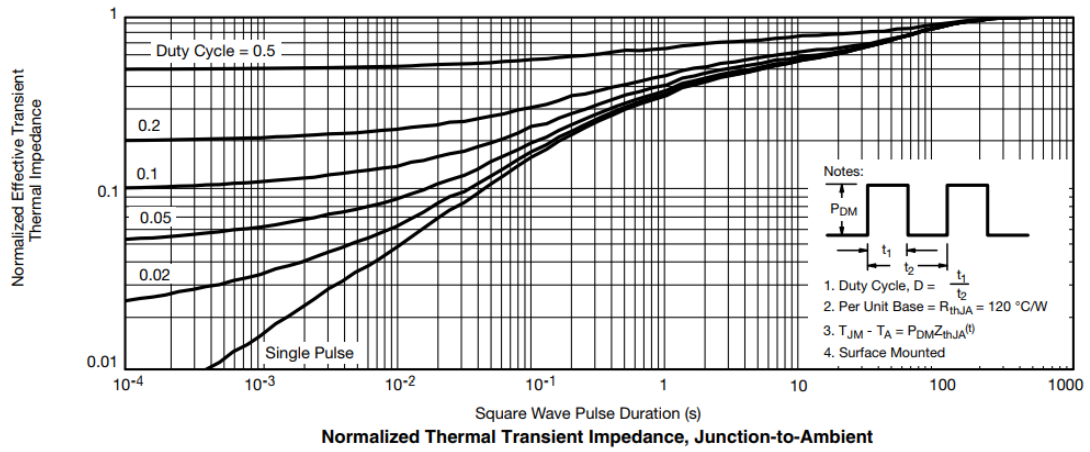
➢ **Package Information**

SOP8
Unit:mm
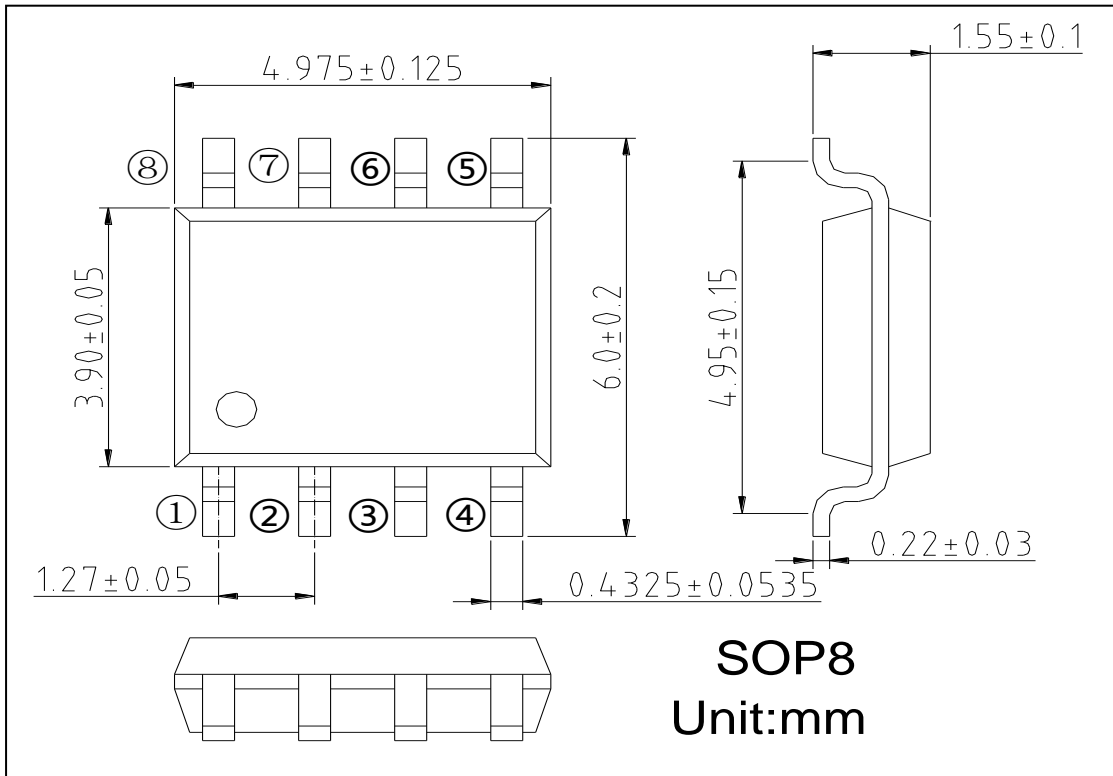
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